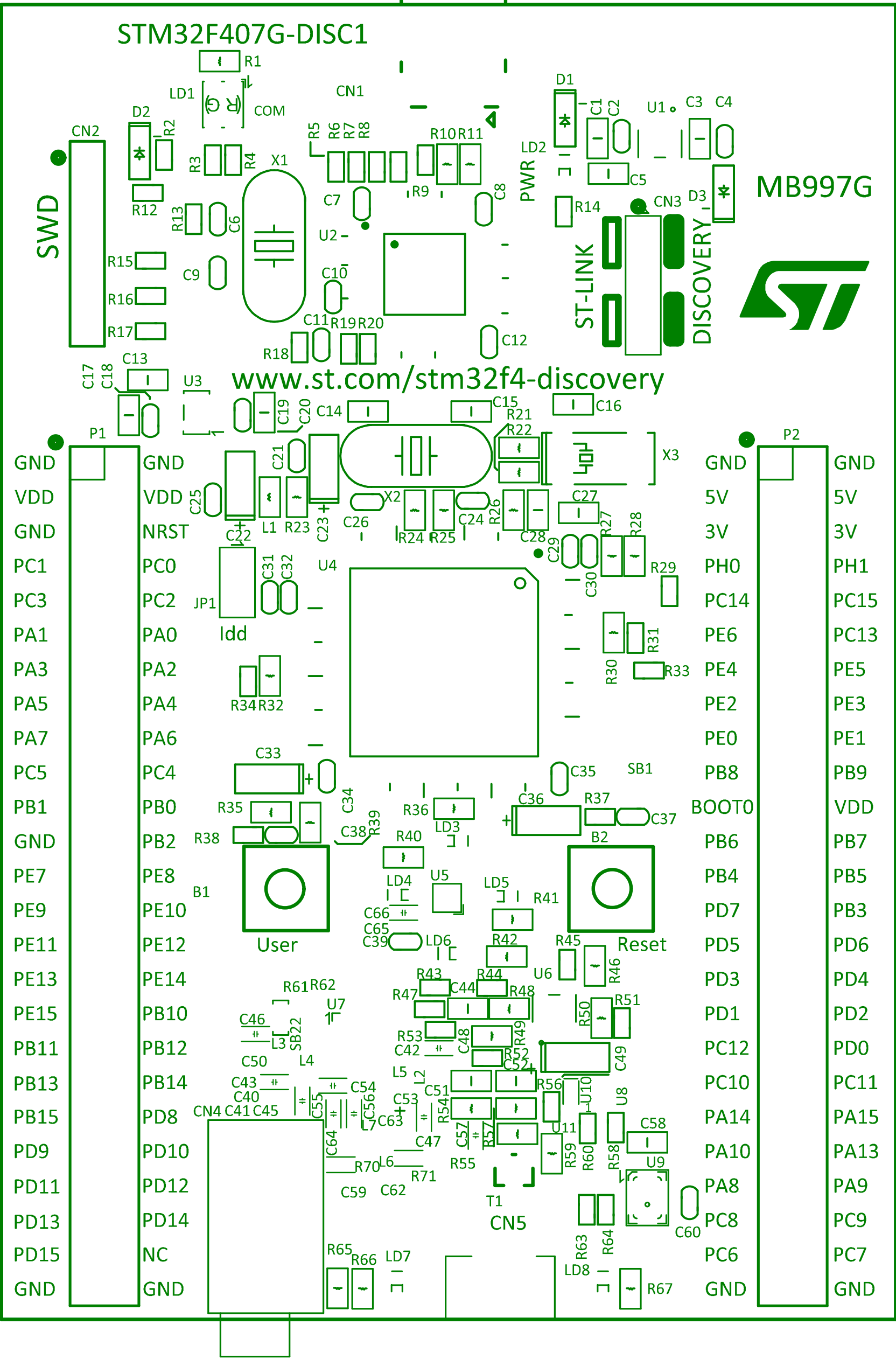
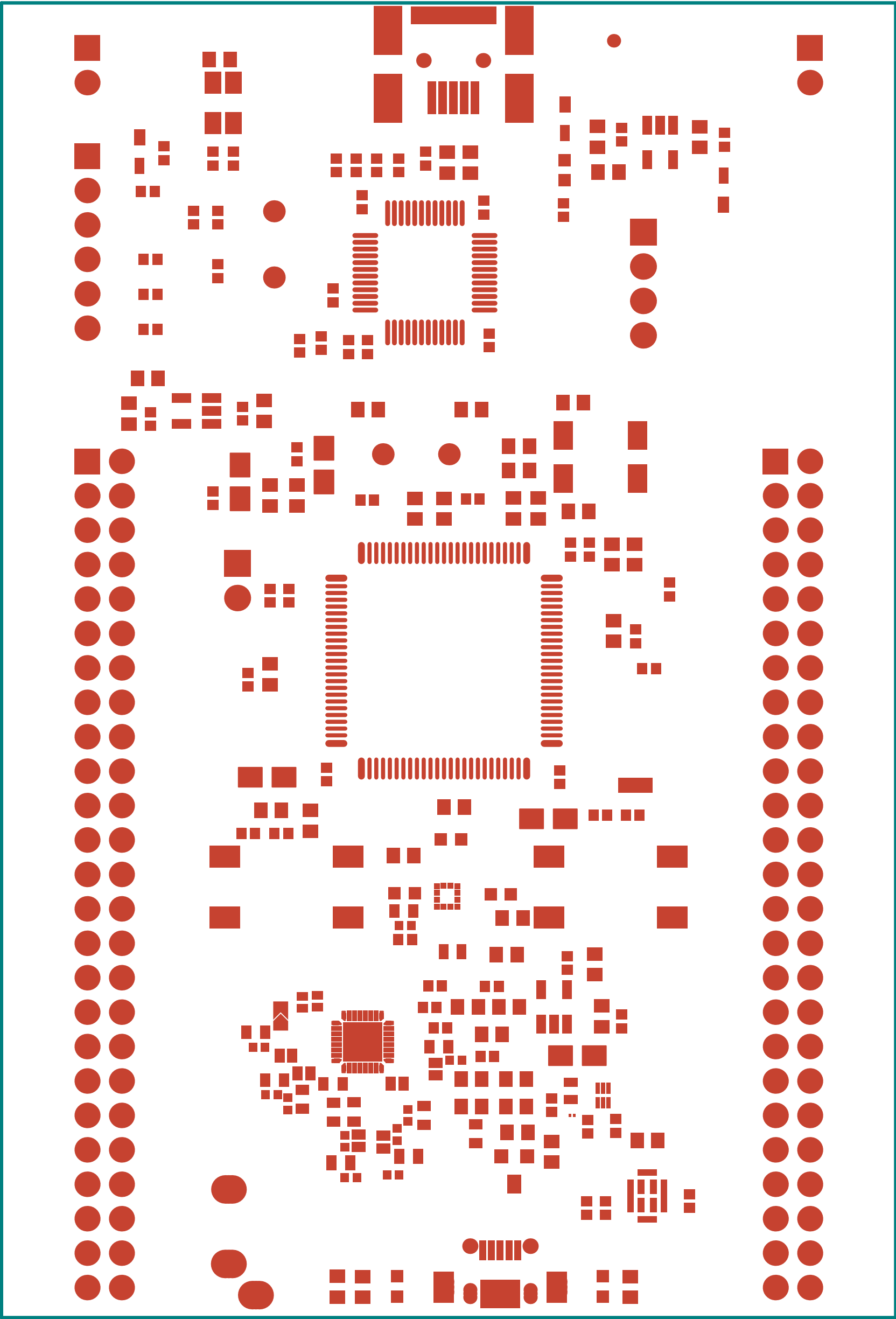
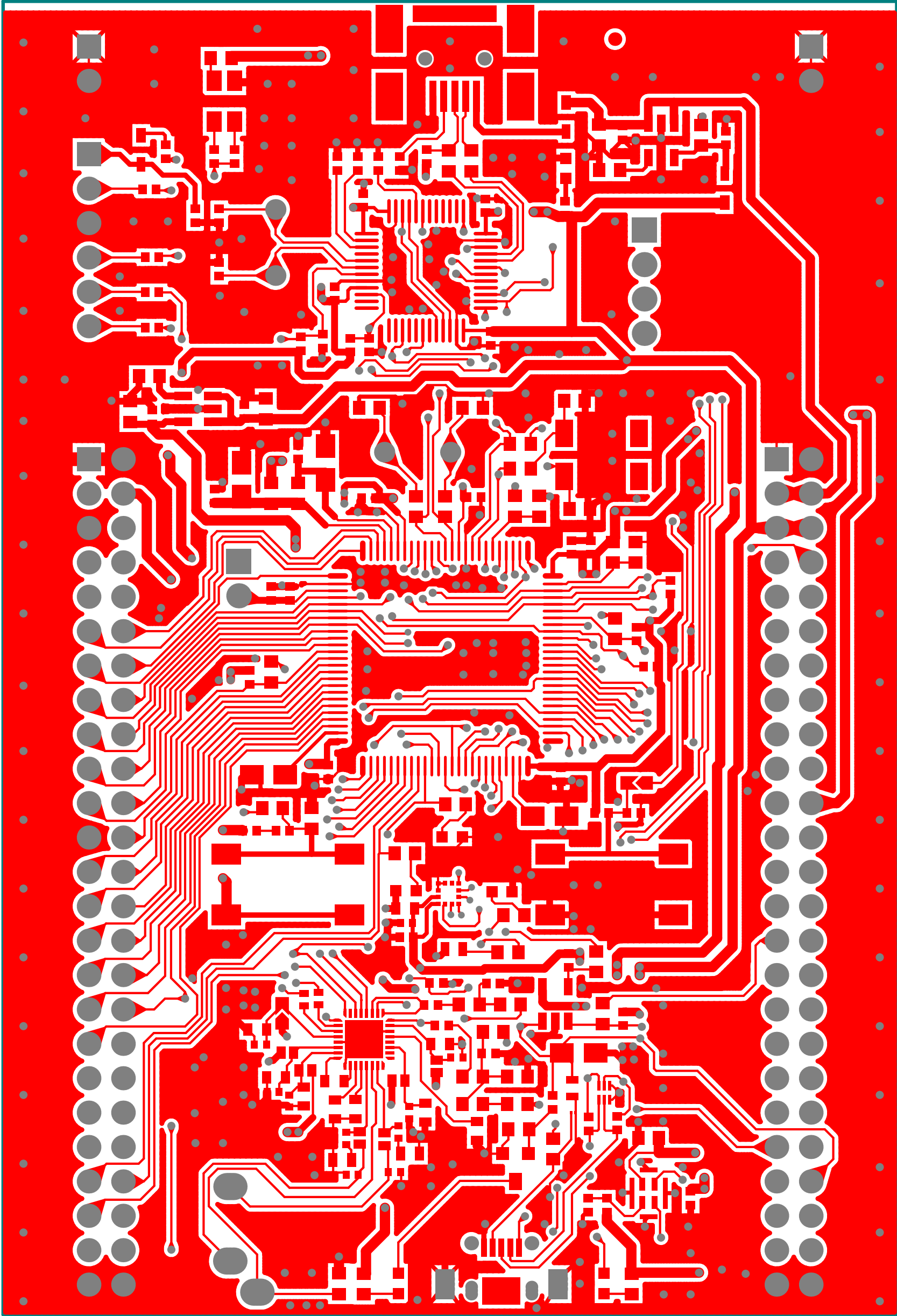




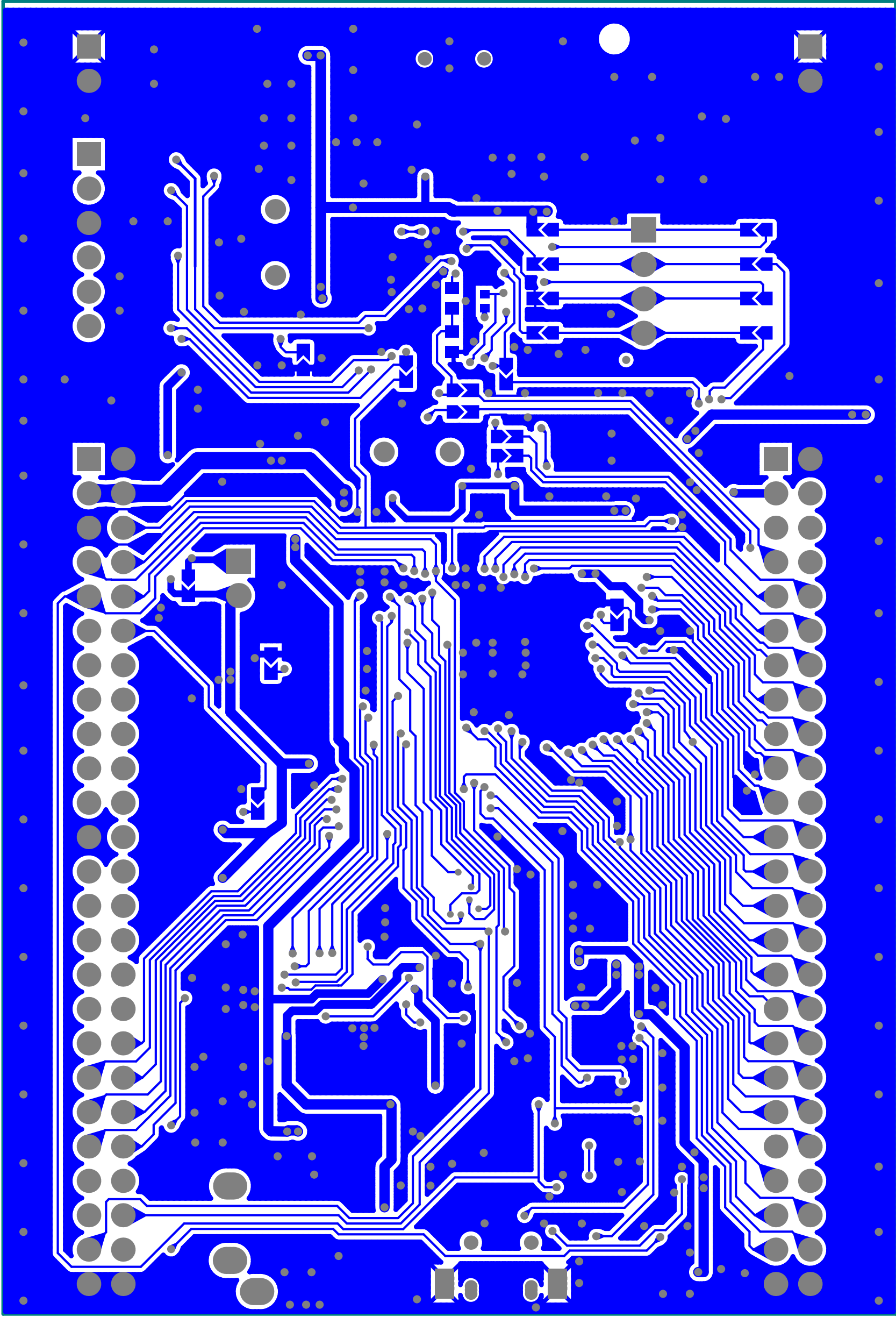
Project: STM32F407G-DISC1		
Layer: TOP Silksceen Overlay	Gerber: .GTO	
Variant: [No Variations]	Ref: MB997	
Date: 04-Dec-2025	Rev: G	



Project: STM32F407G-DISC1		
Layer: TOP Solder Mask	Gerber: .GTS	
Variant: [No Variations]	Ref: MB997	
Date: 04-Dec-2025	Rev: G	



Project: STM32F407G-DISC1		
Layer: TOP Layer	Gerber: .GTL	
Variant: [No Variations]	Ref: MB997	
Date: 04-Dec-2025	Rev: G	



Project: STM32F407G-DISC1

Layer: Bottom Layer

Variant: [No Variations]

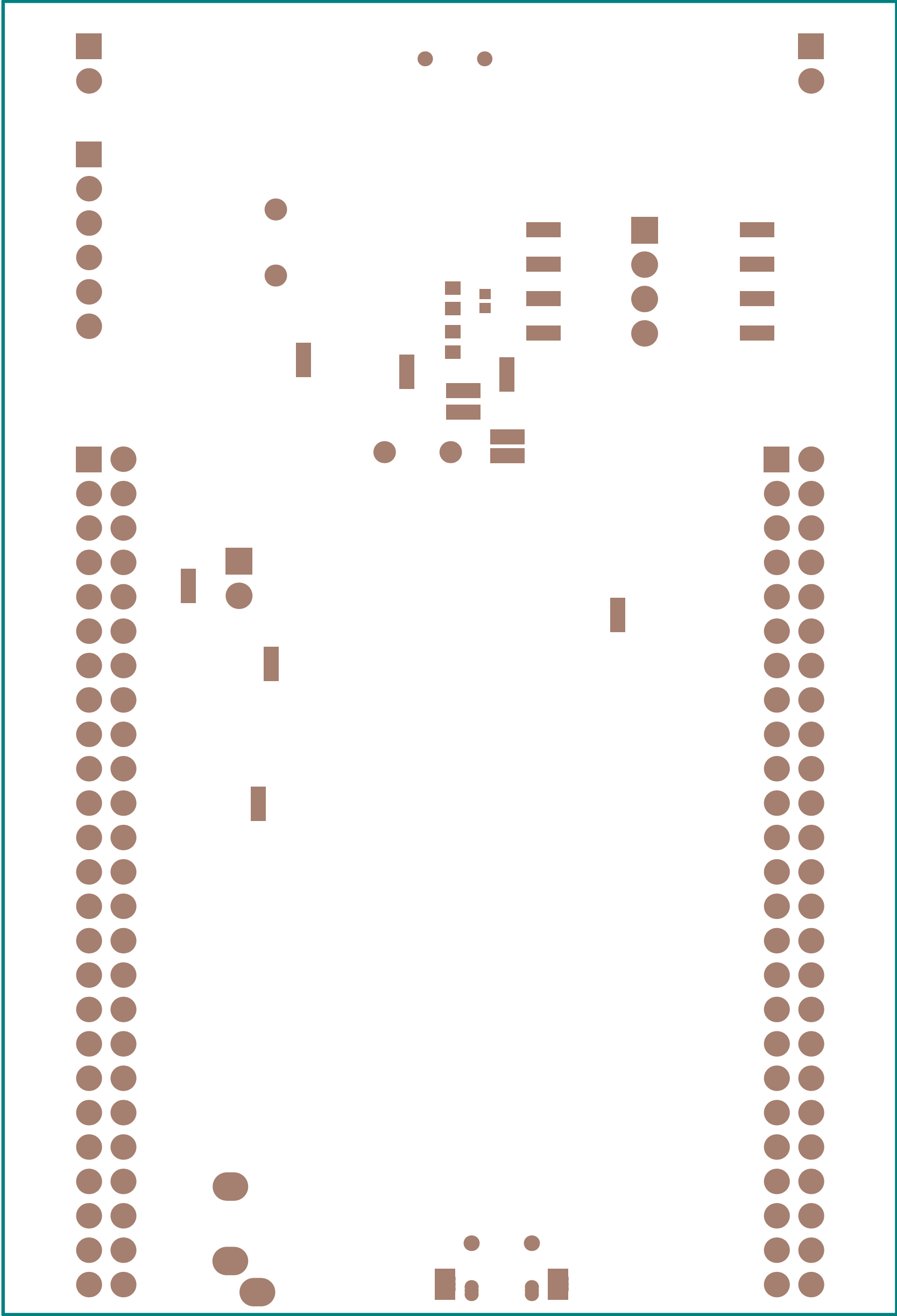
Date: 04-Dec-2025

Gerber: .GBL

Ref: MB007

Rev: G



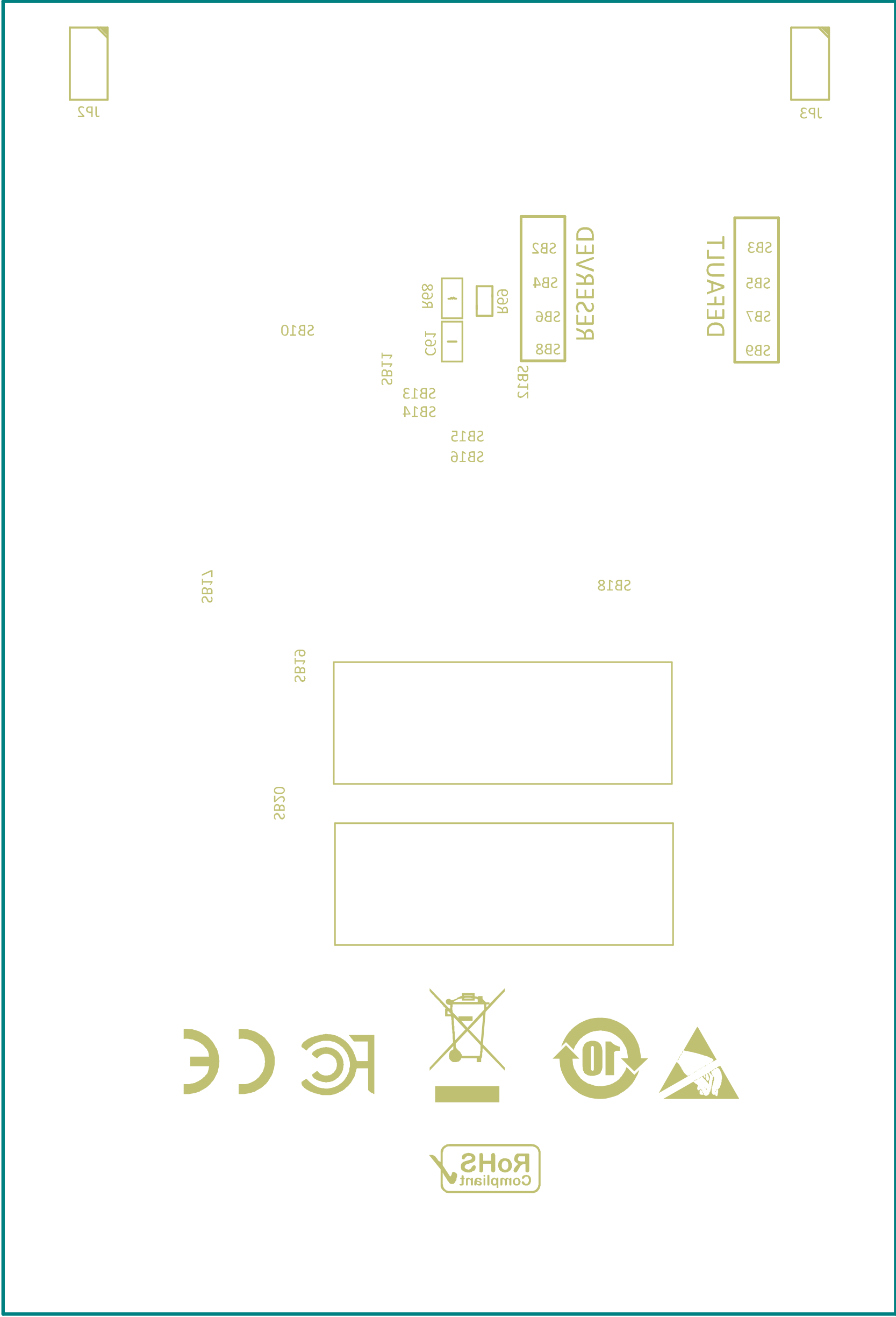


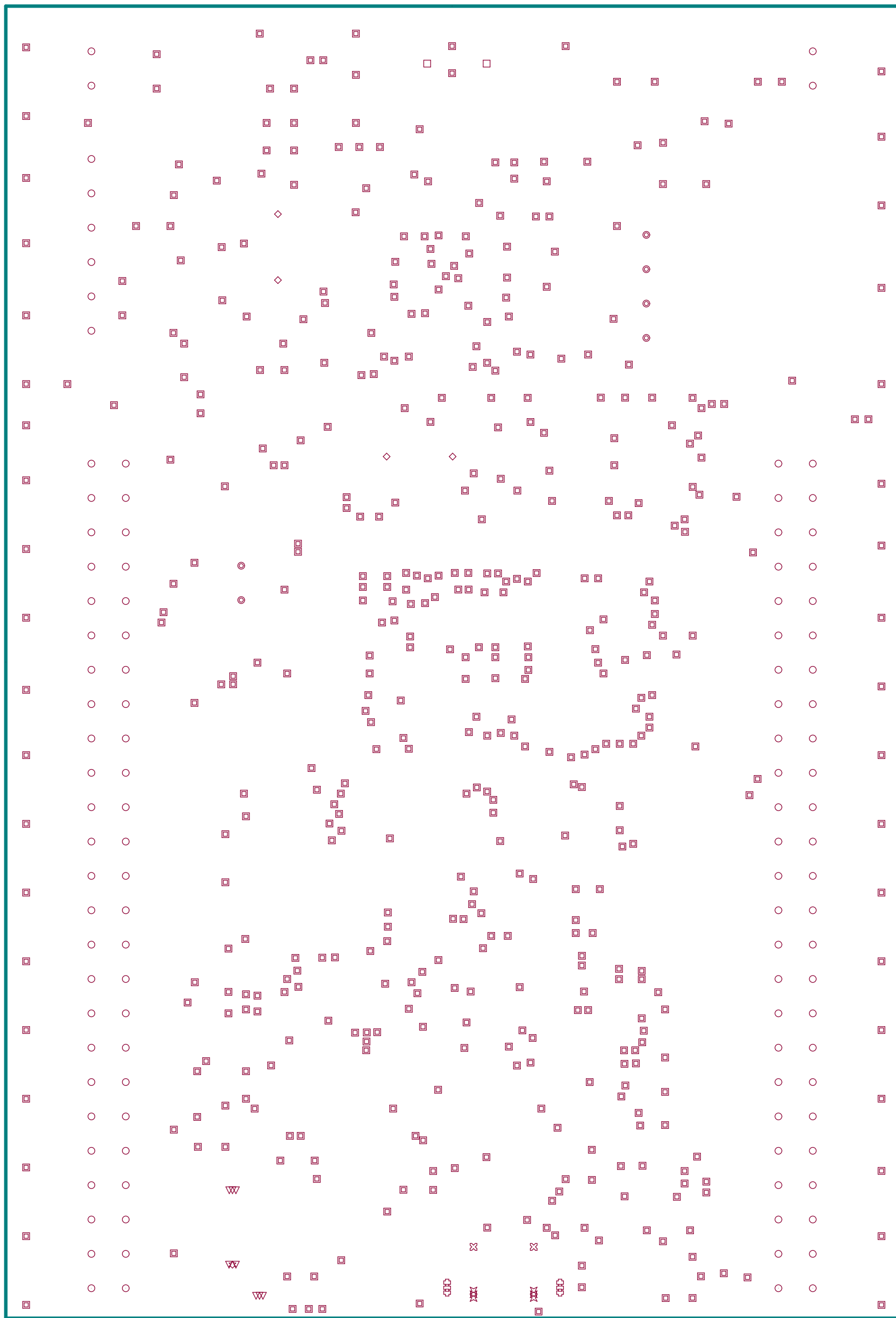
Date: 04-Dec-2025		Rev: G
Variant: [No Variations]		Ref: MB997
Layer: Bottom Solder Mask		Gerber: .GB2
Project: STM32F407G-DISC1		



Date: 04-Dec-2025		Rev: G
Variant: [No Variations]		Ref: MB997
Layer: Bottom silkscreen Overlay		Gerber: .GBO
Project: STM32F407G-DISC1		







Layer	Name	Material	Thickness
1	Silkscreen Top		
2	Solder Mask Top	Solder Resist	0.020mm
3	Top	Copper	0.018mm
4	Dielectric 1	FR-4	1.550mm
5	Bottom	Copper	0.018mm
6	Solder Mask Bottom	Solder Resist	0.020mm
7	Silkscreen Bottom		

Symbol	Hit Count	Finished Hole Size	Plated
	492	0.30mm	PTH
	2	0.65mm	PTH
	4	0.81mm	PTH
	6	0.83mm	PTH
	6	0.90mm	NPTH
	2	1.00mm	NPTH
	6	1.00mm	PTH
	110	1.02mm	PTH
	8	1.20mm	PTH
	1	1.40mm	PTH
	637 Total		

Project: STM32F407G-DISC1		
Layer: Drill drawing	Gerber: .GD1	
Variant: [No Variations]	Ref: MB997	
Date: 04-Dec-2025	Rev: G	